7MBR15XKA065-50

Power Module(X series)
650V / 15A / PIM

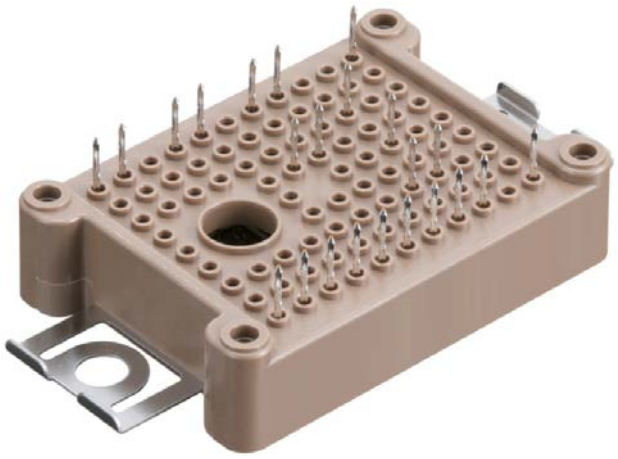
□ Features

Low $V_{CE(sat)}$
Compact Package
P.C.Board Mount Module
Converter Diode Bridge Dynamic Brake Circuit
RoHS compliant Product

□Applications

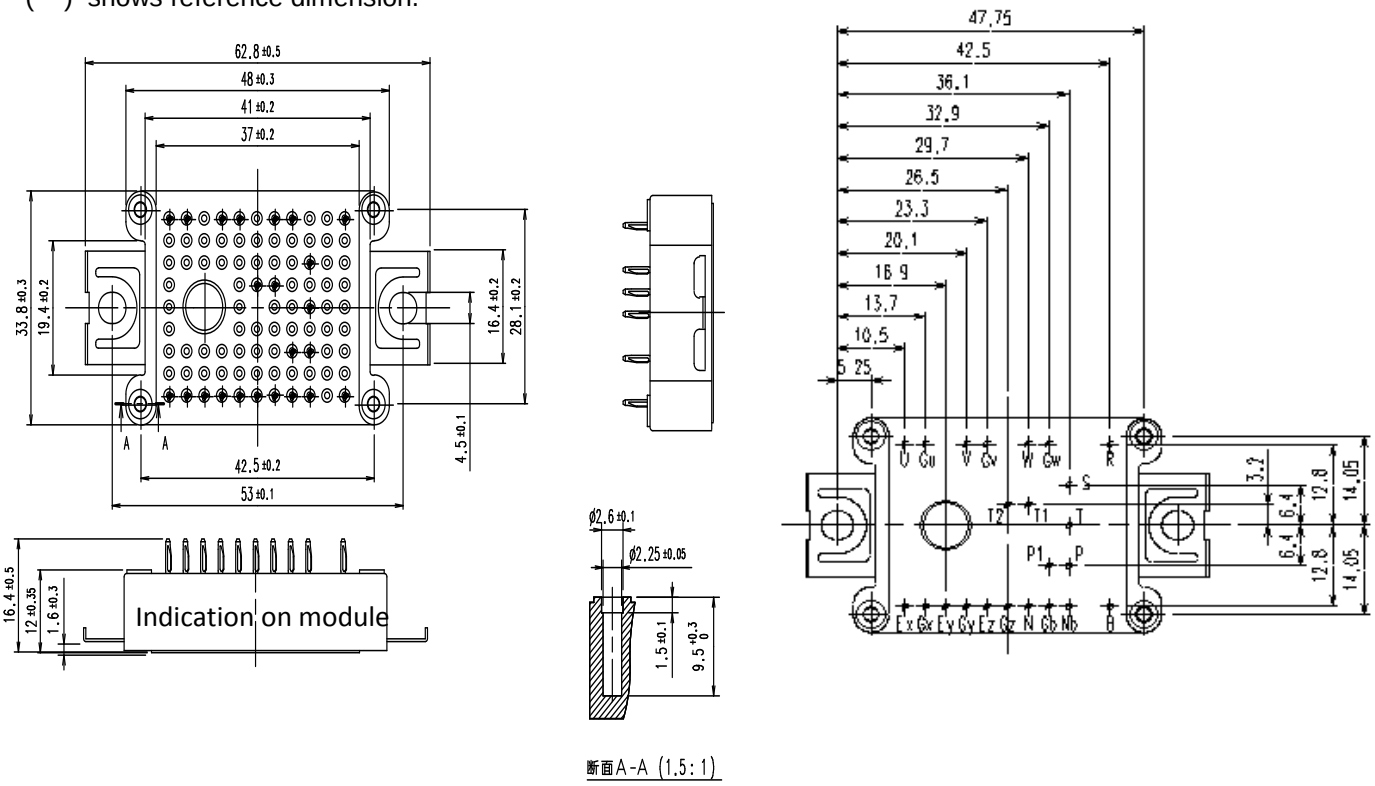
Inverter for Motor Drive
AC and DC Servo Drive Amplifier
Uniterruptible Power Supply

□ Typical appearance



□ Outline drawing (Unit : mm)

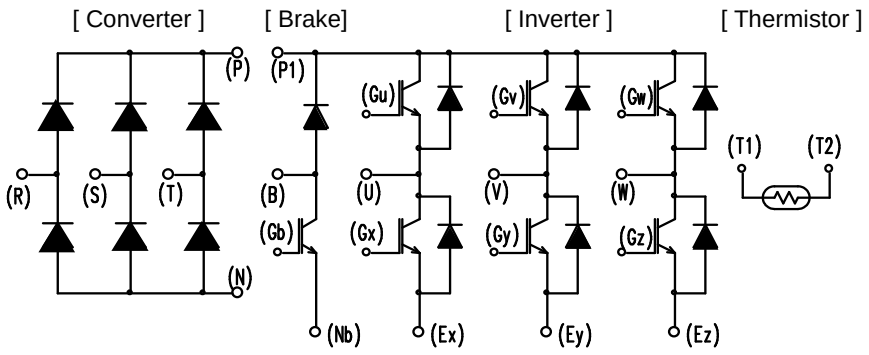
shows theoretical dimension.
( ) shows reference dimension.



Weight: 25 g (typ.)

PIN POSITIONS WITH TOLERANCE ⌖ ø0.4

□ Equivalent circuit



□ Maximum ratings (at T_c = 25°C unless otherwise specified)

	Items		Symbols	Conditions		Maximum ratings	Units
Inverter	Collector-emitter voltage, gate-emitter short-circuited		V_{CES}			650	V
	Gate-emitter voltage, collector-emitter short-circuited		V_{GES}			±20	V
	Collector current		I_C	Continuous	T_c=100°C	15	A
	Repetitive peak collector current		I_{CRM}	1ms		30	
	Forward current		I_F	Continuous		15	
	Repetitive peak forward current		I_{FRM}	1ms		30	
	Total power dissipation		P_{tot}	1 device		110	W
Brake IGBT	Collector-emitter voltage, gate-emitter short-circuited		V_{CES}			650	V
	Gate-emitter voltage, collector-emitter short-circuited		V_{GES}			±20	V
	Collector current		I_C	Continuous	T_c=100°C	15	A
	Repetitive peak collector current		I_{CRM}	1ms		30	
	Total power dissipation		P_{tot}	1 device		110	W
Brake FWD	Forward current		I_F	Continuous		10	A
	Repetitive peak forward current		I_{FRM}	1ms		20	
	Repetitive peak reverse voltage		V_{RRM}			650	V
Converter	Repetitive peak reverse voltage		V_{RRM}			800	V
	Average output current		I_O	Three-phase full wave rectified	T_c=80°C	15	A
	Surge forward current (Non-Repetitive) (*1)		I_{FSM}	t=10ms, Half sine wave form	T_{vj}=25°C	390	A
					T_{vj}=150°C	340	
	I^2t (Non-Repetitive) (*1)		I^2t		T_{vj}=25°C	760	A^2s
					T_{vj}=150°C	585	
Virtual Junction temperature			T_{vj}	Inverter, Brake		175	°C
				Converter		150	
Operating Virtual junction temperature (under switching conditions)			T_{vjop}	Inverter, Brake		175	
				Converter		150	
Case temperature			T_c			125	
Storage temperature			T_{stg}			-40 ~ 125	
Isolation voltage	between terminals and copper base (*2) between thermistor and others (*3)		V_{isol}	A.C. : 1min.		2500	Vrms
Screw torque (*4)	Mounting torque of screws to heat sink		M_s	M4		1.7	N·m

(*1) T_{vj} : Temperature at test start.
(*2) All terminals should be connected together during the test.
(*3) Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test.
(*4) Recommendable value : Mounting 1.3 ~ 1.7 N·m (M4)

Electrical characteristics (at T_{vj} = 25°C unless otherwise specified)

	Items	Symbols	Conditions		Characteristics min.	Characteristics typ.	Characteristics max.	Units
Inverter	Collector-emitter cut-off current, gate-emitter short-circuited	I_{CES}	V_{GE} = 0V V_{CE} = 650V		-	-	50	μA
	Gate leakage current, collector-emitter short-circuited	I_{GES}	V_{CE} = 0V V_{GE} = +20/-20V		-	-	100	nA
	Gate-Emitter threshold voltage	$V_{GE(th)}$	V_{CE} = 20V I_C = 15mA		6.0	6.5	7.0	V
	Collector-Emitter saturation voltage	$V_{CE(sat)}$ (terminal)	V_{GE} = 15V I_C = 15A	T_{vj}=25°C	-	1.45	1.90	V
		$V_{CE(sat)}$ (chip)		T_{vj}=25°C	-	1.30	1.75	
				T_{vj}=125°C	-	1.45	-	
				T_{vj}=150°C	-	1.50	-	
				T_{vj}=175°C	-	1.55	-	
	Internal Gate resistance	r_g	-		-	0	-	Ω
	Capacitance	C_{ies}	V_{CE} = 10V, V_{GE} =0V, f = 1MHz		-	1.7	-	nF
		C_{oes}			-	0.07	-	
		C_{res}			-	0.02	-	
	Gate charge	Q_G	V_{CC} = 300V V_{GE}=-15 → +15V I_C = 15A		-	120	-	nC
	Forward voltage	V_F (terminal)	I_F = 15A	T_{vj}=25°C	-	1.65	2.10	V
		V_F (chip)		T_{vj}=25°C	-	1.50	1.95	
				T_{vj}=125°C	-	1.45	-	
				T_{vj}=150°C	-	1.45	-	
				T_{vj}=175°C	-	1.40	-	
	Switching time (*1)	$t_{d(on)}$	V_{CC} = 300V I_C,I_F = 15A L_s = 30nH V_{GE} = +15/-15 V R_G = 24 Ω	T_{vj}=25°C	-	0.05	-	μs
				T_{vj}=125°C	-	0.05	-	
				T_{vj}=150°C	-	0.05	-	
				T_{vj}=175°C	-	0.05	-	
		t_r	V_{CC} = 300V I_C,I_F = 15A L_s = 30nH V_{GE} = +15/-15 V R_G = 24 Ω	T_{vj}=25°C	-	0.02	-	
				T_{vj}=125°C	-	0.02	-	
				T_{vj}=150°C	-	0.02	-	
				T_{vj}=175°C	-	0.02	-	
		$t_{d(off)}$	V_{CC} = 300V I_C,I_F = 15A L_s = 30nH V_{GE} = +15/-15 V R_G = 24 Ω	T_{vj}=25°C	-	0.15	-	
				T_{vj}=125°C	-	0.17	-	
				T_{vj}=150°C	-	0.18	-	
				T_{vj}=175°C	-	0.18	-	
		t_f	V_{CC} = 300V I_C,I_F = 15A L_s = 30nH V_{GE} = +15/-15 V R_G = 24 Ω	T_{vj}=25°C	-	0.03	-	
				T_{vj}=125°C	-	0.04	-	
				T_{vj}=150°C	-	0.05	-	
				T_{vj}=175°C	-	0.05	-	
	Reverse recovery time	t_{rr}	V_{CC} = 300V I_C,I_F = 15A L_s = 30nH V_{GE} = +15/-15 V R_G = 24 Ω	T_{vj}=25°C	-	0.06	-	
				T_{vj}=125°C	-	0.10	-	
				T_{vj}=150°C	-	0.12	-	
				T_{vj}=175°C	-	0.13	-	

(*1) Turn on time (t_{on}) = $t_{d(on)}$ + t_r , Turn off time (t_{off}) = $t_{d(off)}$ + t_f

	Items	Symbols	Conditions		Characteristics min.	Characteristics typ.	Characteristics max.	Units
Inverter	Switching loss (per pulse)	E_{on}	V_{CC} = 300V, I_C,I_F = 15A, L_s = 30nH, V_{GE} = +15/-15 V, R_G = 24 Ω	T_{vj}=25°C	-	0.12	-	mJ
				T_{vj}=125°C	-	0.17	-	
				T_{vj}=150°C	-	0.20	-	
				T_{vj}=175°C	-	0.23	-	
		E_{off}	V_{CC} = 300V, I_C,I_F = 15A, L_s = 30nH, V_{GE} = +15/-15 V, R_G = 24 Ω	T_{vj}=25°C	-	0.38	-	
				T_{vj}=125°C	-	0.47	-	
				T_{vj}=150°C	-	0.50	-	
				T_{vj}=175°C	-	0.53	-	
		E_{rr}	V_{CC} = 300V, I_C,I_F = 15A, L_s = 30nH, V_{GE} = +15/-15 V, R_G = 24 Ω	T_{vj}=25°C	-	0.12	-	
				T_{vj}=125°C	-	0.21	-	
				T_{vj}=150°C	-	0.26	-	
				T_{vj}=175°C	-	0.30	-	
Brake	Collector-emitter cut-off current, gate-emitter short-circuited	I_{CES}	V_{GE} = 0V, V_{CE} = 650V		-	-	50	μA
	Gate leakage current, collector-emitter short-circuited	I_{GES}	V_{CE} = 0V, V_{GE} = +20/-20V		-	-	100	nA
	Collector-Emitter saturation voltage	$V_{CE(sat)}$ (terminal)	V_{GE} = 15V, I_C = 15A	T_{vj}=25°C	-	1.45	1.90	V
		$V_{CE(sat)}$ (chip)		T_{vj}=25°C	-	1.30	1.75	
				T_{vj}=125°C	-	1.45	-	
				T_{vj}=150°C	-	1.50	-	
				T_{vj}=175°C	-	1.55	-	
	Internal Gate resistance	r_g	-		-	0	-	Ω
	Switching time (*1)	$t_{d(on)}$	V_{CC} = 300V, I_C = 15A, L_s = 30nH, V_{GE} = +15/-15 V, R_G = 24 Ω	T_{vj}=25°C	-	0.05	-	μs
				T_{vj}=125°C	-	0.05	-	
				T_{vj}=150°C	-	0.05	-	
				T_{vj}=175°C	-	0.05	-	
		t_r	V_{CC} = 300V, I_C = 15A, L_s = 30nH, V_{GE} = +15/-15 V, R_G = 24 Ω	T_{vj}=25°C	-	0.02	-	
				T_{vj}=125°C	-	0.02	-	
				T_{vj}=150°C	-	0.02	-	
				T_{vj}=175°C	-	0.02	-	
		$t_{d(off)}$	V_{CC} = 300V, I_C = 15A, L_s = 30nH, V_{GE} = +15/-15 V, R_G = 24 Ω	T_{vj}=25°C	-	0.15	-	
				T_{vj}=125°C	-	0.17	-	
				T_{vj}=150°C	-	0.18	-	
				T_{vj}=175°C	-	0.18	-	
		t_f	V_{CC} = 300V, I_C = 15A, L_s = 30nH, V_{GE} = +15/-15 V, R_G = 24 Ω	T_{vj}=25°C	-	0.03	-	
				T_{vj}=125°C	-	0.04	-	
				T_{vj}=150°C	-	0.05	-	
				T_{vj}=175°C	-	0.05	-	
	Reverse current	I_{RRM}	V_R = 650V		-	-	50	μA
	Forward voltage	V_F (terminal)	I_F = 10A	T_j=25°C	-	1.70	2.15	V
		V_F (chip)	I_F = 10A	T_{vj}=25°C	-	1.55	2.00	
				T_{vj}=125°C	-	1.50	-	
				T_{vj}=150°C	-	1.50	-	
				T_{vj}=175°C	-	1.45	-	
Converter	Reverse current	I_{RRM}	V_R = 800V		-	-	50	μA
	Continuous (direct) forward voltage	V_F	I_F = 15A	terminal	-	1.10	1.55	V
				chip	-	0.95	1.40	
Thermistor	Resistance	R	T = 25°C		-	5000	-	Ω
			T = 100°C		465	495	520	
	B value	B	T = 25/ 50°C		3305	3375	3450	K

(*1) Turn on time (t_{on}) = $t_{d(on)}$ + t_r , Turn off time (t_{off}) = $t_{d(off)}$ + t_f

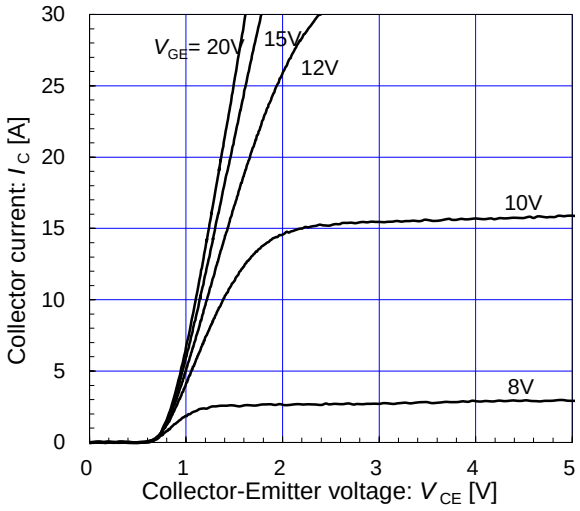
NOTICE:
The external gate resistance (R_G) shown above is one of our recommended value for the purpose of minimum switching loss. However the optimum R_G depends on circuit configuration and/or environment. We recommend that the R_G has to be carefully chosen based on consideration if IGBT module matches design criteria, for example, switching loss, EMC/EMI, spike voltage, surge current and no unexpected oscillation and so on.

□Thermal resistance characteristics

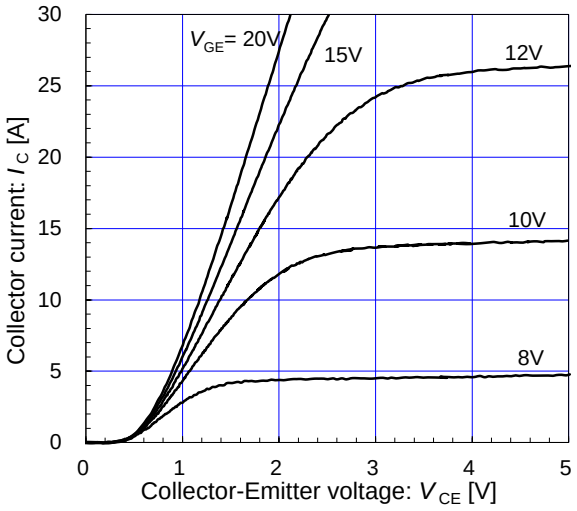
Items	Symbols	Conditions	Characteristics			Units
			min.	typ.	max.	
Thermal resistance junction to case (1 device)	$R_{th(j-c)}$	Inverter IGBT	-	-	1.31	°C/W
		Inverter FWD	-	-	1.50	
		Brake IGBT	-	-	1.31	
		Brake FWD	-	-	1.92	
		Converter Diode	-	-	0.75	
Thermal resistance case to heat sink(*1) (1 device)	$R_{th(c-s)}$	Inverter IGBT	-	0.81	-	
		Inverter FWD	-	0.92	-	
		Brake IGBT	-	0.84	-	
		Brake FWD	-	0.80	-	
		Converter Diode	-	0.79	-	

(*1) This is the value which is defined mounting on the additional cooling fin with 1 W/(m･K) thermal grease.

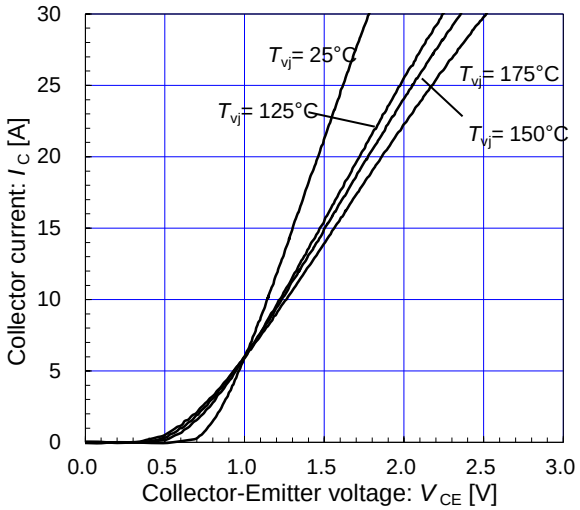
[Inverter]
Collector current vs. Collector-Emitter voltage (typ.)
T_{vj}= 25°C / chip



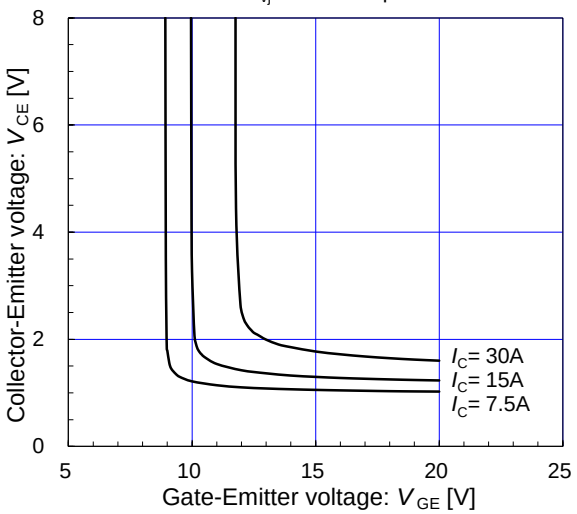
[Inverter]
Collector current vs. Collector-Emitter voltage (typ.)
T_{vj}= 175°C / chip



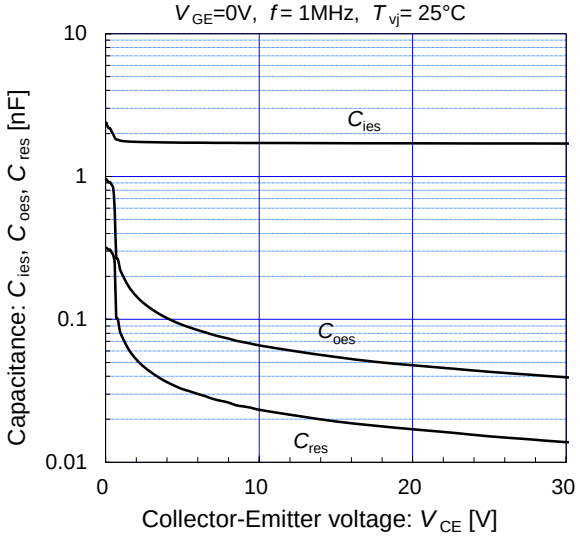
[Inverter]
Collector current vs. Collector-Emitter voltage (typ.)
V_{GE}=15V / chip



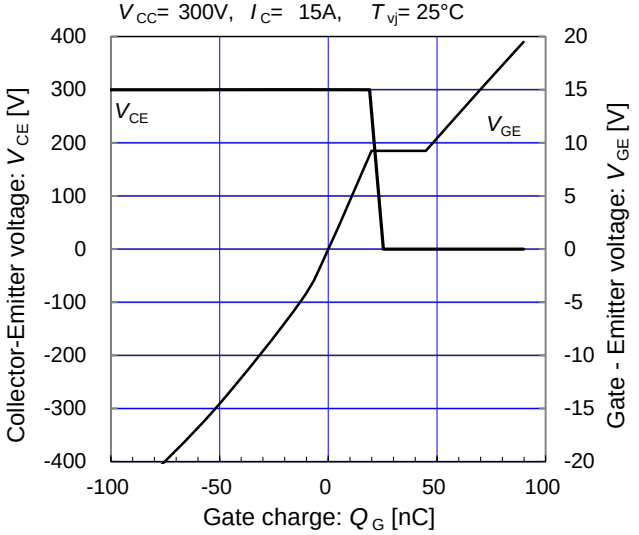
[Inverter]
Collector-Emitter voltage vs. Gate-Emitter voltage (typ.)
T_{vj}= 25°C / chip



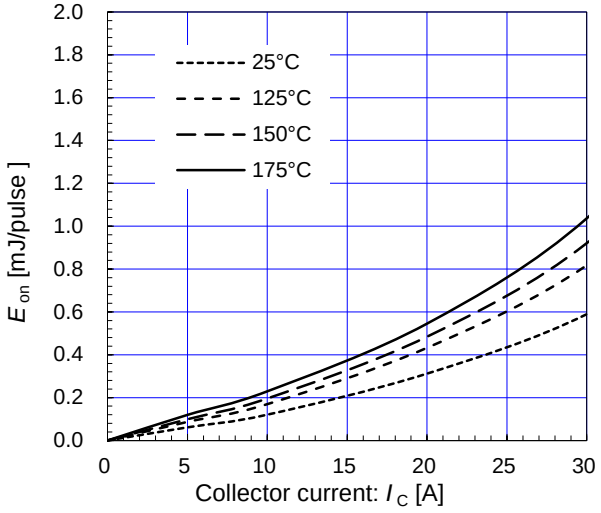
[Inverter]
Capacitance vs. Collector-Emitter voltage (typ.)
V_{GE}=0V, f= 1MHz, T_{vj}= 25°C



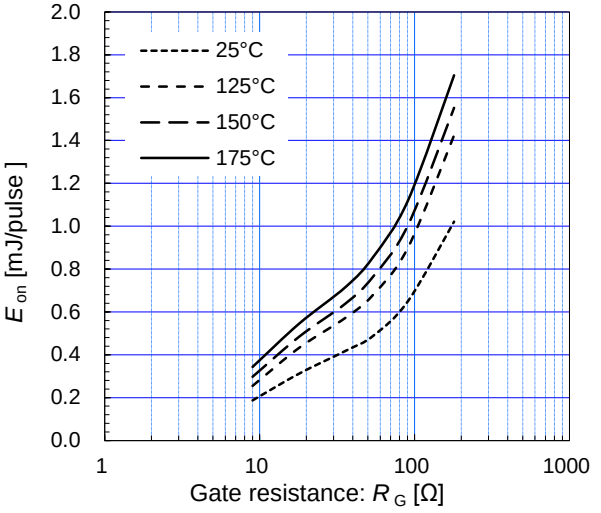
[Inverter]
Dynamic Gate charge (typ.)
V_{CC}= 300V, I_C= 15A, T_{vj}= 25°C



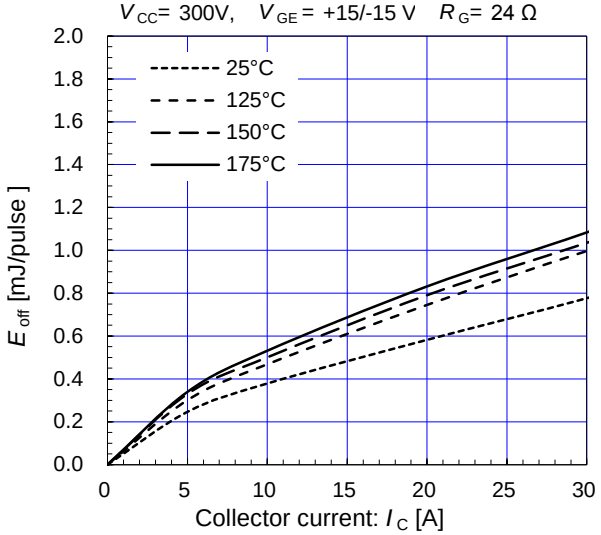
[Inverter]
E_{on} vs. Collector current (typ.)
V_{CC}= 300V, V_{GE} = +15/-15 V R_G= 24 Ω



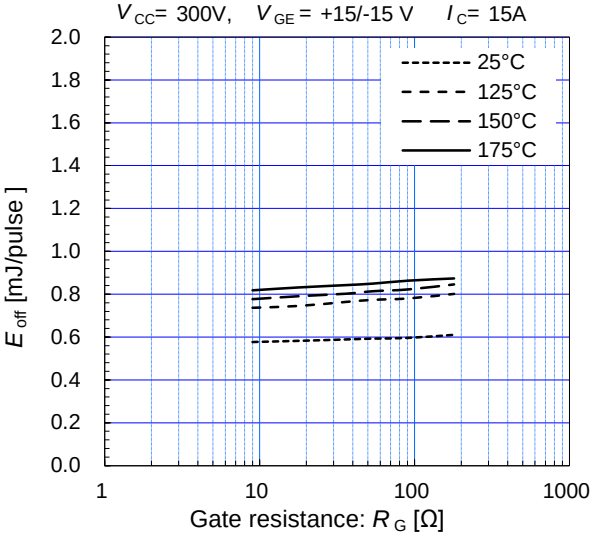
[Inverter]
E_{on} vs. Gate resistance (typ.)
V_{CC}= 300V, V_{GE} = +15/-15 V I_C= 15A



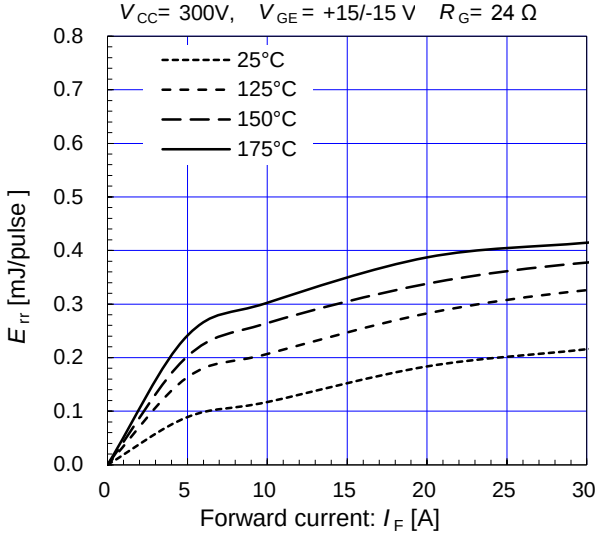
[Inverter]
E_{off} vs. Collector current (typ.)
V_{CC}= 300V, V_{GE} = +15/-15 V R_G= 24 Ω



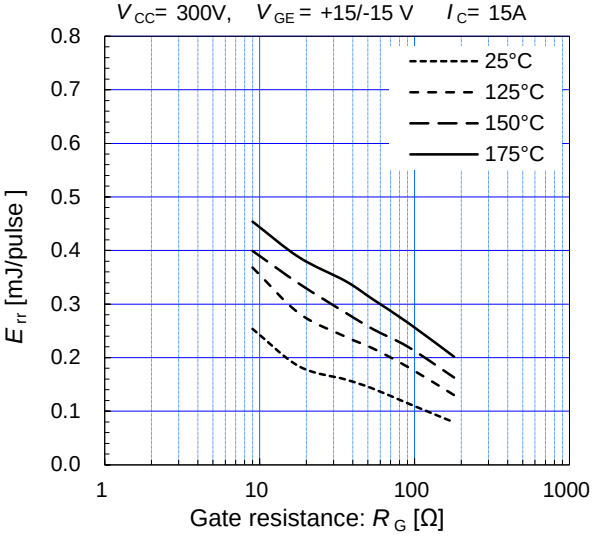
[Inverter]
E_{off} vs. Gate resistance (typ.)
V_{CC}= 300V, V_{GE} = +15/-15 V I_C= 15A



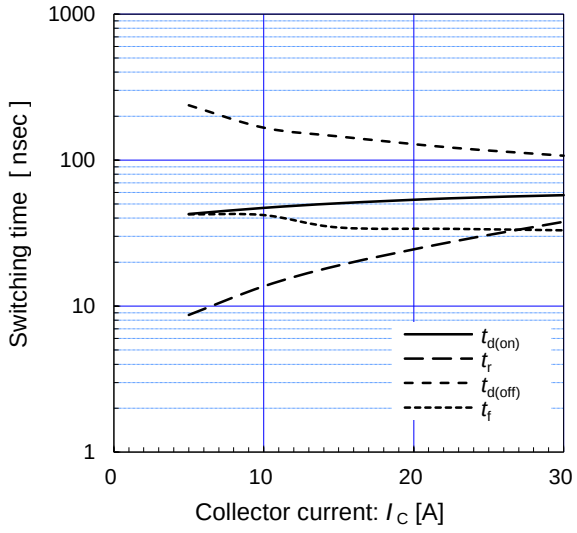
[Inverter]
E_{rr} vs. Forward current (typ.)
V_{CC}= 300V, V_{GE} = +15/-15 V R_G= 24 Ω



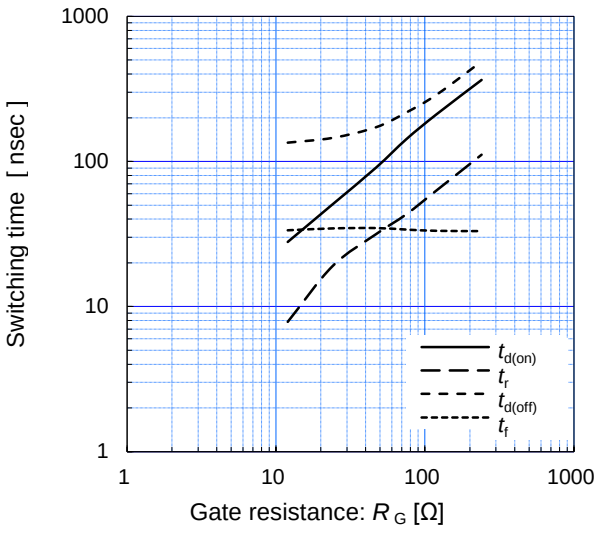
[Inverter]
E_{rr} vs. Gate resistance (typ.)
V_{CC}= 300V, V_{GE} = +15/-15 V I_C= 15A



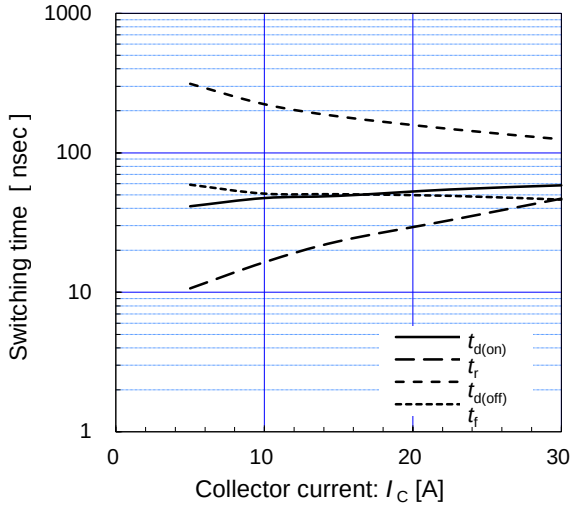
[Inverter]
Switching time vs. Collector current (typ.)
V_{CC}= 300V, R_G= 24Ω V_{GE}= +15/-15 V, T_{vj}= 25°C



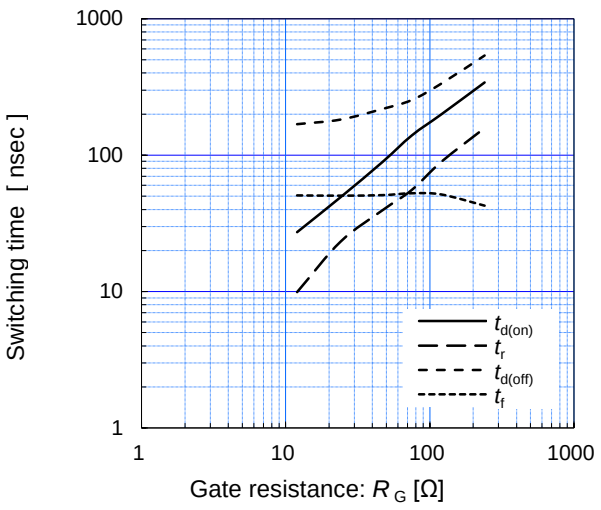
[Inverter]
Switching time vs. Gate resistance (typ.)
V_{CC}= 300V, I_C= 15A, V_{GE}= +15/-15 V, T_{vj}= 25°C



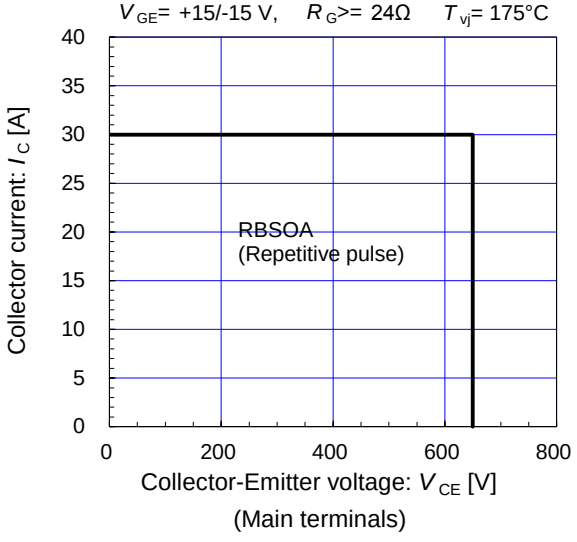
[Inverter]
Switching time vs. Collector current (typ.)
V_{CC}= 300V, R_G= 24Ω V_{GE}= +15/-15 V, T_{vj}= 175°C



[Inverter]
Switching time vs. Gate resistance (typ.)
V_{CC}= 300V, I_C= 15A, V_{GE}= +15/-15 V, T_{vj}= 175°C



[Inverter]
Reverse bias safe operating area (max.)
V_{GE}= +15/-15 V, R_G>= 24Ω T_{vj}= 175°C

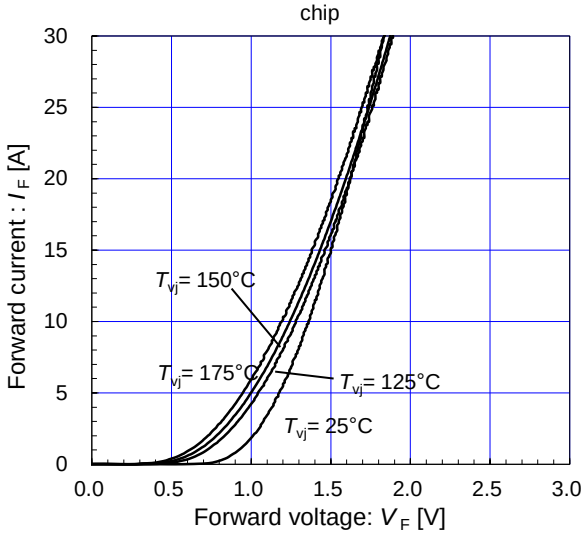


(Main terminals)

[Inverter]

Forward current vs. Forward voltage (typ.)

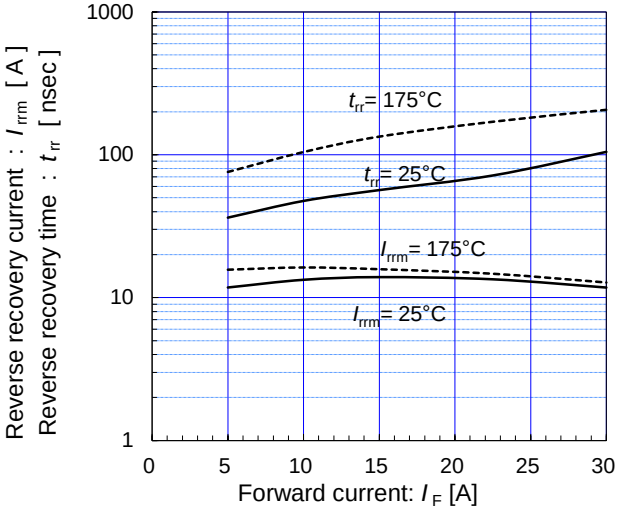
chip



[Inverter]

Reverse recovery characteristics (typ.)

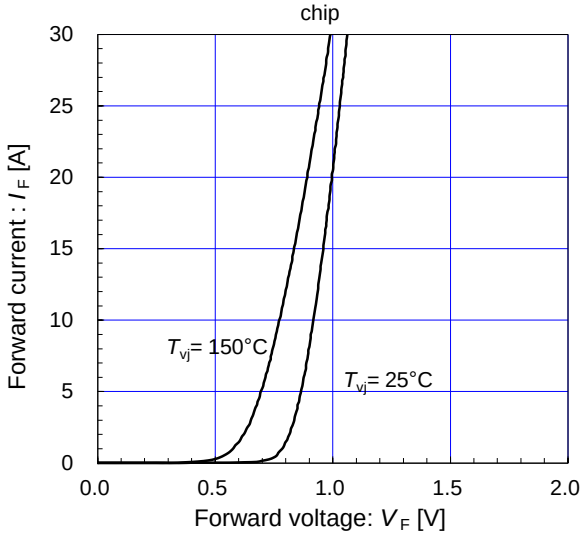
V_{CC}= 300V, V_{GE}= +15/-15 V, R_G= 24Ω



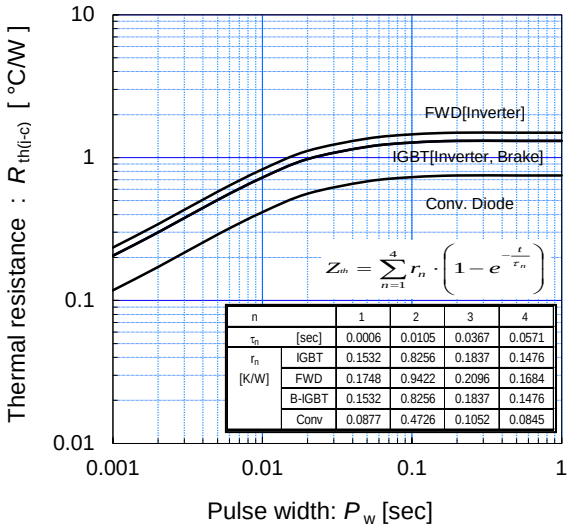
[Converter]

Forward current vs. Forward voltage (typ.)

chip



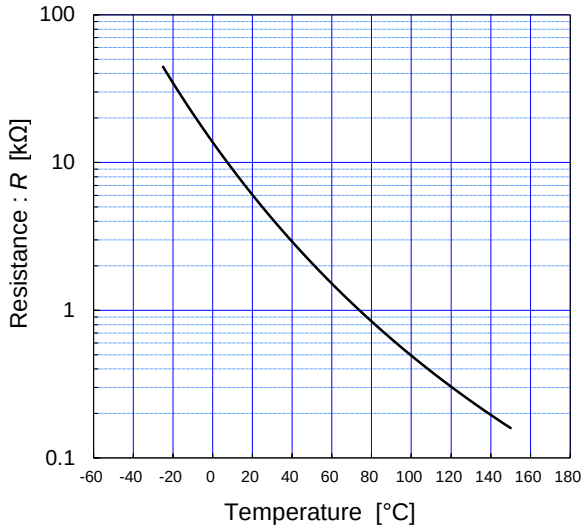
Transient thermal resistance (max.)



n		1	2	3	4
τ_n	[sec]	0.0006	0.0105	0.0367	0.0571
r_n [K/W]	IGBT	0.1532	0.8256	0.1837	0.1476
	FWD	0.1748	0.9422	0.2096	0.1684
	B-IGBT	0.1532	0.8256	0.1837	0.1476
	Conv	0.0877	0.4726	0.1052	0.0845

[Thermistor]

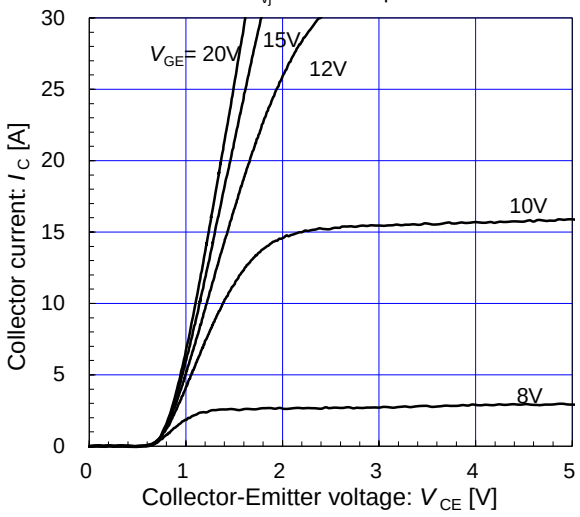
Temperature characteristic (typ.)



[Brake]

Collector current vs. Collector-Emitter voltage (typ.)

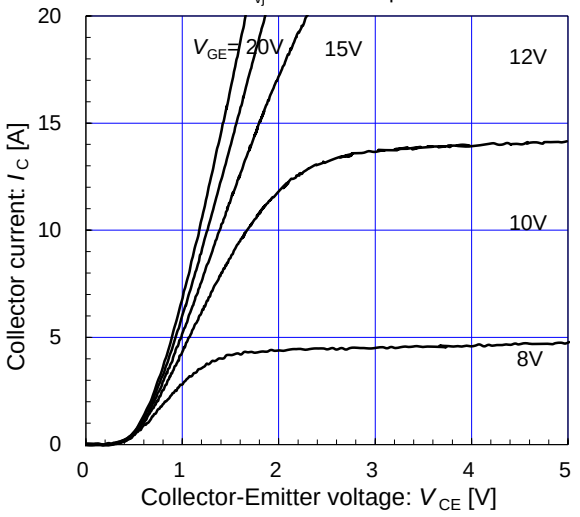
T_{vj}= 25°C / chip



[Brake]

Collector current vs. Collector-Emitter voltage (typ.)

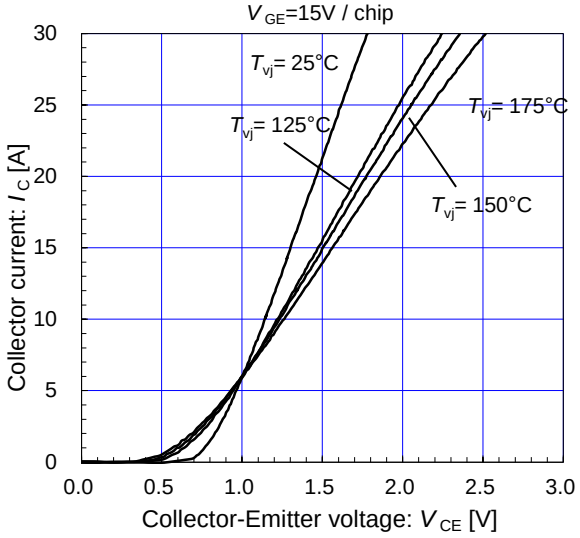
T_{vj}= 175°C / chip



[Brake]

Collector current vs. Collector-Emitter voltage (typ.)

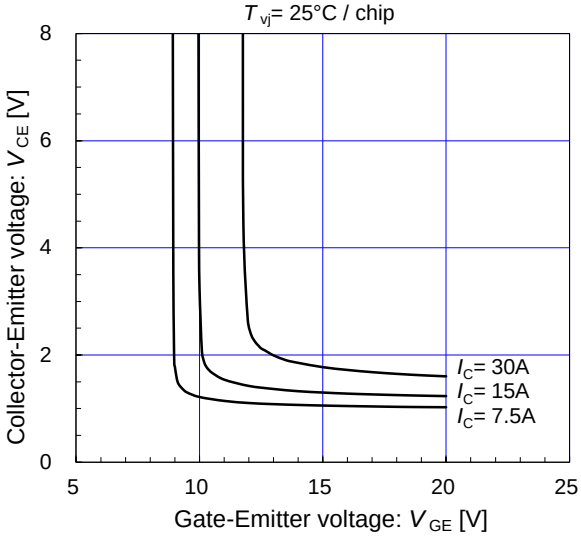
V_{GE}=15V / chip



[Brake]

Collector-Emitter voltage vs. Gate-Emitter voltage (typ.)

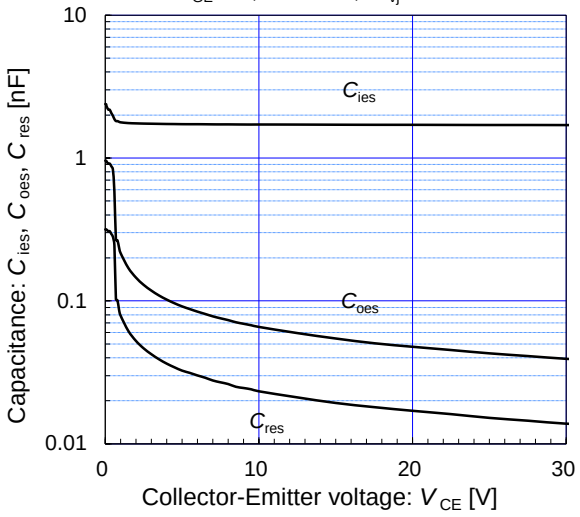
T_{vj}= 25°C / chip



[Brake]

Capacitance vs. Collector-Emitter voltage (typ.)

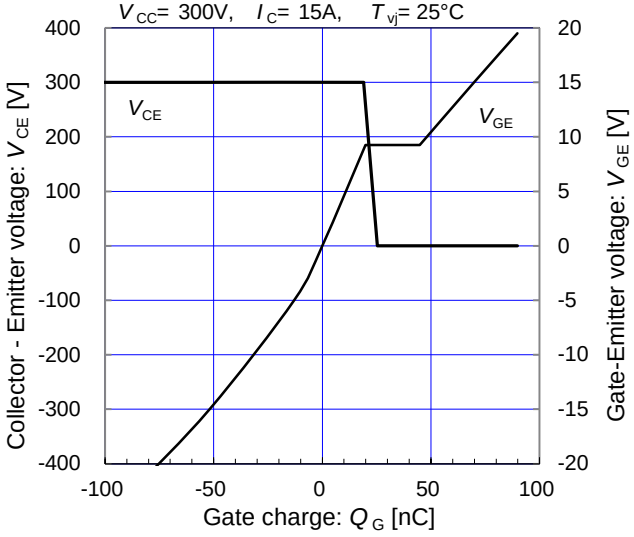
V_{GE}=0V, f= 1MHz, T_{vj}= 25°C



[Brake]

Dynamic Gate charge (typ.)

V_{CC}= 300V, I_C= 15A, T_{vj}= 25°C



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1. This Catalog contains the product specifications, characteristics, data, materials, and structures as of 1/2018. The contents are subject to change without notice for specification changes or other reasons. When using a product listed in this Catalog, be sure to obtain the latest specifications.

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・Machine tools ・Audiovisual equipment ・Electrical home appliances ・Personal equipment ・Industrial robots etc.

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・Emergency equipment for responding to disasters and anti-burglary devices ・Safety devices ・Medical equipment

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7.

8. If you have any question about any portion in this Catalog, ask Fuji Electric Co., Ltd. or its sales agents before using the product. Neither Fuji Electric Co., Ltd. nor its agents shall be liable for any injury caused by any use of the products not in accordance with instructions set forth herein.

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